

# ACP-2153

## Environment Test Report

Report NO: 12P020018

Summary	<p><input checked="" type="checkbox"/> <b>Pass</b></p> <p><input type="checkbox"/> <b>Fail</b></p> <p>Note : There is/are ____ defect(s) not list in the report, please check it in the DTS Website.</p> <p><input type="checkbox"/> <b>Pass with Deviation</b></p>
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**Issue date**

**2012-10-03**

**Approval**

**Tom Lin**

**Test Engineer**

**Matthew Chi**

## Test item list

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### Testing Result

Num	Test item list	Result	Remark
1	Temperature rise test	Pass	
2	Temperature cycle operation test	Pass	
3	High temperature storage test	Pass	
4	Low temperature storage test	Pass	
5	Humidity test	Pass	
6	Cold start and hot start test	Pass	

# Configuration of EUT

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Item	Device Information	
SYSTEM PC Model / Ver.	ACP-2153 A1.0	
CPU Board	GENE-CV05 A1.0	
BIOS / Version	AEP-5153 R0.2(A5153M02)(08/30/2012)	
CPU Type	Intel Atom D2550 1.86GHz	
Memory Type	Transcend DDR3 1333 4GB Samsung SEC HCH9 K4B2G0846C	
HDD	TOSHIBA MK1060GSC 2.5" 100G	
Operating System	<input checked="" type="checkbox"/>	Windows 7 Professional English 32 Bit
DC Adapter	FSP084-DAMM1/ DC 12V/ 7.0A	

## System picture:



# Temperature rise test

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**Test Date:** 10-02-2012

**Test Product:** ACP-2153

**Test Site:** AAEON QE Dept.

**Test Standard:** Reference EN 61131-2(94), UL508 (94)

**Temperature Measurement:**

40 Channel Thermal Recorder:

YOKOGAWA Inc,

Model: DA100-13-1D

Date of Calibration: 10/12/2011

Serial Number: 12A323190

**Test Condition:**

Ambient temperature: 60°C

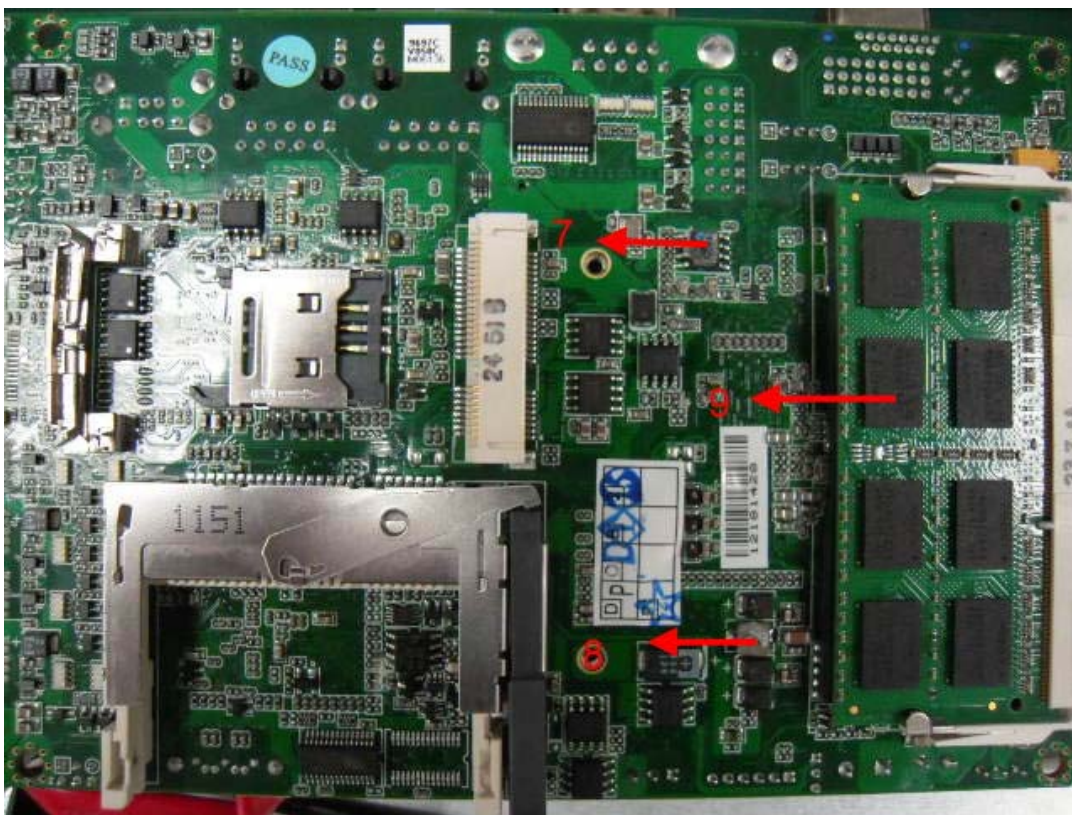
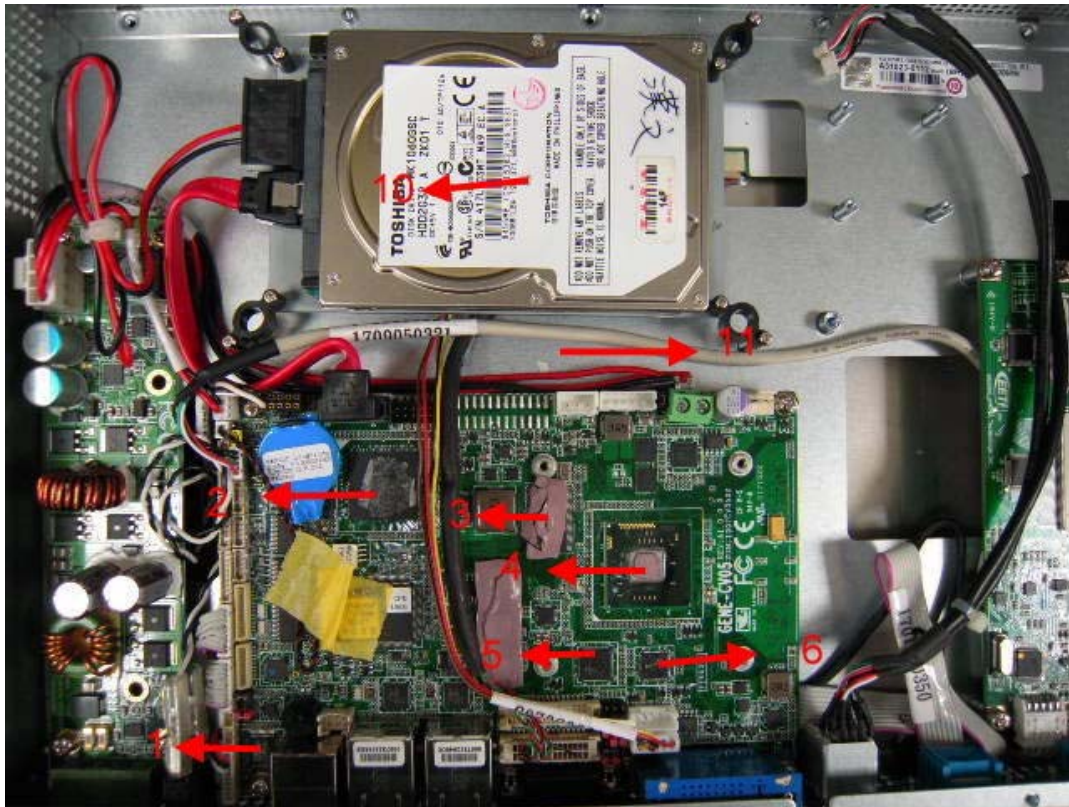
Continuous running till thermal stable (within less than 1°C)

**Test Software:**

Windows 7 / Run PassMark Burn In Test 7.0 Pro

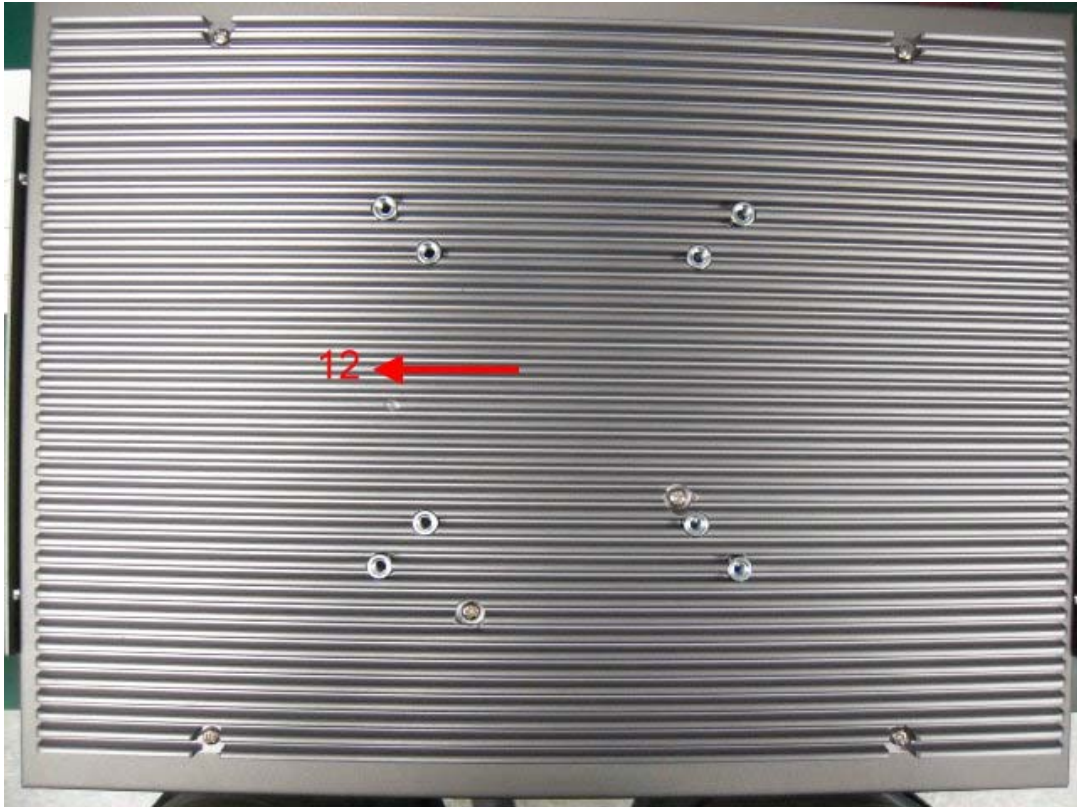
**Terminal Recorder:**

# Temperature rise test



# Temperature rise test

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# Temperature rise test

## Thermal profile data:

Point	Temp. Stage(°C)	Spec	60	Note
01. U42 - (TF)AUDIO CODEC.REALTEK.ALC662-GR		100.5	87.1	
02. U7 - (TF)NM10 Express Chipset.INTEL.CG82NM10.SLGXX		115	86.4	
03. U13 - (TF)CLOCK GENERATOR.IDT.9LPRS501PGLF		95	73.2	
04. U17 - Intel Atom D2550 1.86GHz		100	74.9	
05. U29 - (TF)DisplayPort to LVDS Converter.Chrontel.CH7511B-BF		85	75.9	
06. U31 - (TF)Digital Video Level Shifter..PERICOM.PI3VDP411LSZBE		85	74.6	
07. U57 - (TF)Regulator.ANPEC.APL5912-KAC-TR		100	80.5	
08. L7 - (TF)COIL.ZenithTek.ZPWM-4020MP-1R		125	84.9	
09. Memory - Transcend DDR3 1333 4GB Samsung SEC HCH9 K4B2G0846C		85	79.1	
10. HDD - TOSHIBA MK1060GSC 2.5" 100G		85	78.6	
11. Control Box Inside Air Temperature		N/A	74.8	
12. Control Box Surface Temperature		N/A	69.1	
13. Chamber Air Temperature		N/A	60.2	

### Note(\*):

1. "Tc" indicates the component's case maximum temperature value specified in its datasheet.
2. "Tm" indicates the measured Tc value under working environmental temperature within product specification.
3. **Judgment Criteria:**
  - **Fail** :  $T_m > T_c$ ; The measured value is over specification plus margin.
  - **Margin** :  $T_c > T_m > T_c - 5^\circ\text{C}$ ; The measured value is within specification with margin.  
For FANLESS system application, it is strongly recommended to add thermal dissipation design for better reliability.
  - **Pass** :  $T_m < T_c - 5^\circ\text{C}$ ; The measured value is with safety margin.

## Sample Configuration & Quantity Under Test:

Quantity: 1 (ACP-2153)

## Test Result:

No issues were found during the temperature rise operation test.

# Temperature cycle test

**Test Date:** 09-28~ 10-01-2012

**Test Product:** ACP-2153

**Test Site:** AAEON QE Dept.

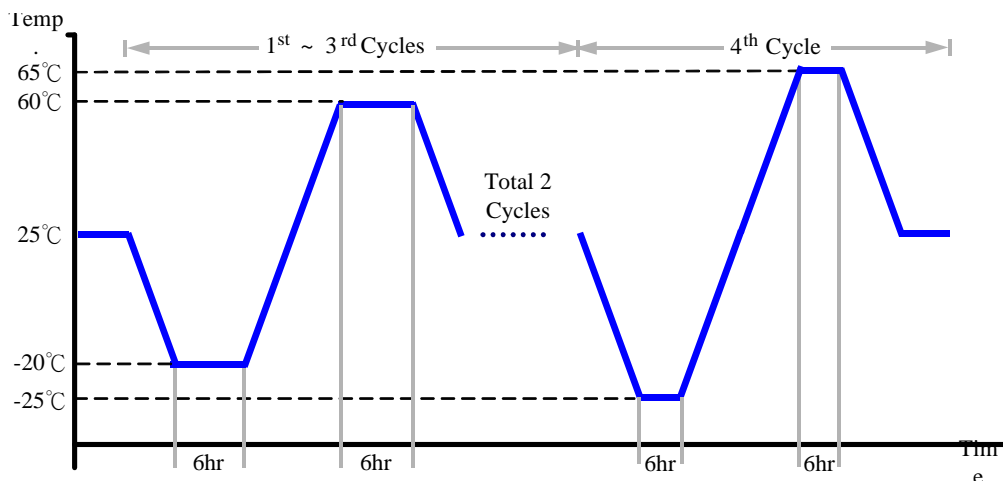
**Test Standard:** Refer to IEC68-2-14 Testing procedures  
Test N: Change of temperature Test

**Test Equipment:**

Programmable Temperature & Humidity Chamber  
K.SON. INS. TECH. CORP.  
Model: THS-D75-100+LN2  
Date of Calibration: 10/13/11  
Serial Number: 6487KT

**Test Condition:**

1. Test Low Temperature: -20°C (1~3 cycles)  
-25°C (4<sup>th</sup> cycle)
2. Test High Temperature: 60°C (1~3 cycles)  
65°C (4<sup>th</sup> cycle)
3. Test dwell time: 6Hrs
4. Temperature slope: 2°C/min
5. Test cycle: 4 cycles
6. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (ACP-2153)

**Test Result:**

No issues were found during the temperature operation cycle test.



# High temperature storage test

**Test Date:** 09-26 ~ 27-2012

**Test Product:** ACP-2153

**Test Site:** AAEON QE Dept.

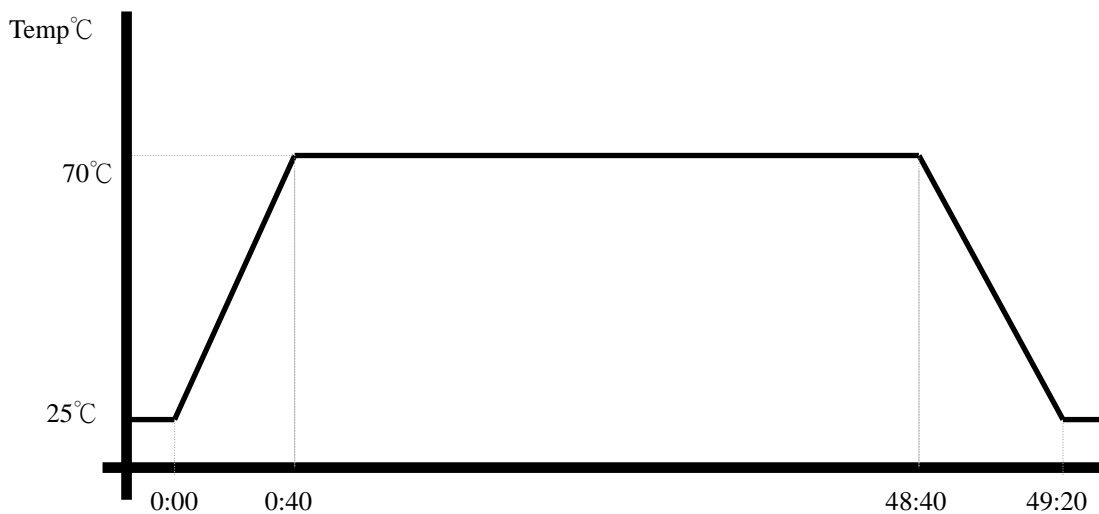
**Test Standard:** Refer to IEC 68-2-2 Testing procedures  
Test Bb: Dry Heat Test (Non-operation)

**Test Equipment:**

Programmable Temperature & Humidity Chamber  
K.SON. INS. TECH. CORP.  
Model: THS-D75-100+LN2  
Date of Calibration: 10/13/11  
Serial Number: 6487KT

**Testing Item:**

1. Test Temperature: 70°C
2. Test Times: 48Hrs
3. Test Software: Windows 7 / Run PassMark Burn In Test 7.0 Pro
4. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (ACP-2153)

**Test Result:**

No issues were found after the high temperature storage test.

# Low temperature storage test

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**Test Date:** 09-25 ~ 26-2012

**Test Product:** ACP-2153

**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to IEC 68-2-1 Testing procedures  
Test Ab: Cold Test (Non-operation)

**Test Equipment:**

Programmable Temperature & Humidity Chamber  
K.SON. INS. TECH. CORP.

Model: THS-D75-100+LN2

Date of Calibration: 10/13/11

Serial Number: 6487KT

**Testing Item:**

1. Test Temperature: -20°C
2. Test Times: 48Hrs
3. Test Software: Windows 7 / Run PassMark Burn In Test 7.0 Pro
4. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (ACP-2153)

**Test Result:**

No issues were found after the low temperature storage test.

# Humidity test

**Test Date:** 10-01 ~ 02-2012

**Test Product:** ACP-2153

**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to IEC 68-2-3 Testing procedures  
Test Ca: Damp heat, steady state (Non-operation)

**Test Equipment:**

Programmable Temperature & Humidity Chamber

K.SON. INS. TECH. CORP.

Model: THS-D75-100+LN2

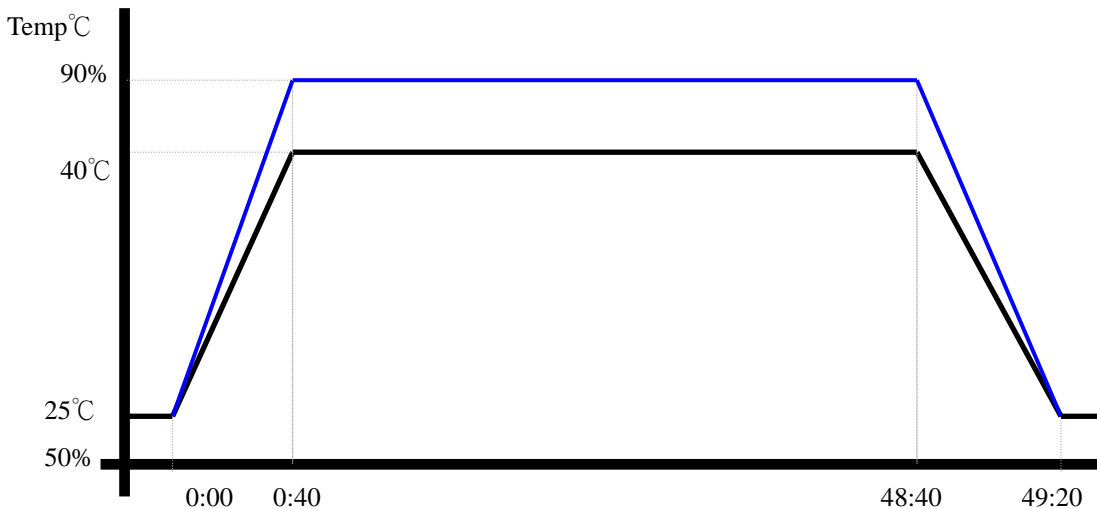
Date of Calibration: 10/13/11

Serial Number: 6487KT

**Testing Item:**

1. Test Temperature: 40°C
2. Test Humidity: 90%RH
3. Test Times: 48Hrs
4. Test Software: Windows 7 / Run PassMark Burn In Test 7.0 Pro
5. Test Environment Curve:

**Humidity %**



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (ACP-2153)

**Test Result:**

No issues were found after the humidity storage test.

# Cold start and hot start test

**Test Date:** 09-26 ~27-2012

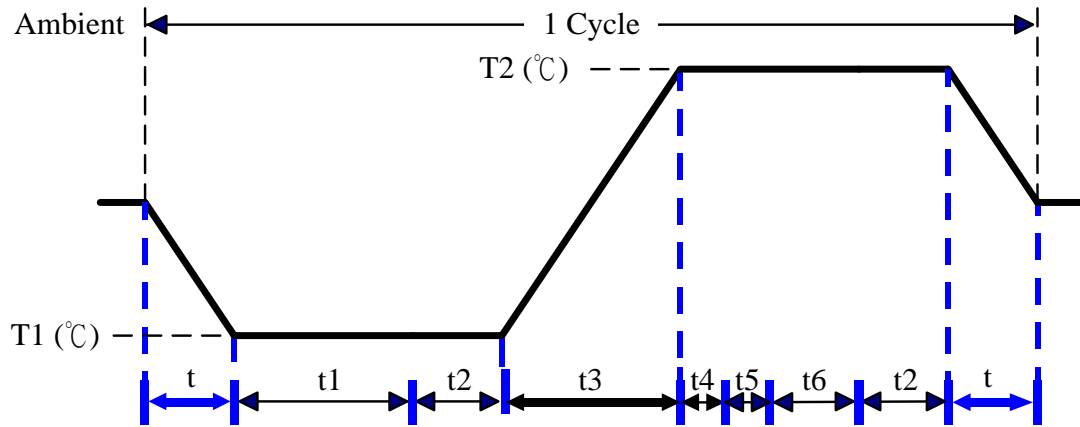
**Test Product:** ACP-2153

**Test Site:** AAEON QE Dept.

**Test Standard:** Refer to IEC 68-2-14 Testing procedures  
Test N: Change of temperature Test

**Test Equipment:**  
 Programmable Temperature & Humidity Chamber  
 K.SON. INS. TECH. CORP.  
 Model: THS-D75-100+LN2  
 Date of Calibration: 10/13/11  
 Serial Number: 6487KT

**Test Condition:**



Parameters	Description
T1	-25°C
T2	65°C
t1	4 hrs
t2, t6	2 hrs
t4, t5	1hrs
t, t3	2°C/min
n (Cycle)	1

t = temperature slope  
 t, t1, t6: Power Off  
 t2: Power on/off test 10 times (on 2 min / off 5min)  
 t3, t4: Run media player  
 t5: Win 7 Software restart test 3 times  
 Test Software: Windows 7

**Test Result:**

- a. No issues were found during the cold start test.
- b. No issues were found during the hot start test.